### 503557895 11/06/2015

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3604522

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HUILUN DENG	03/20/2015

#### **RECEIVING PARTY DATA**

Name:	SHENZHEN LITCKCONN TECHNOLOGY CO.,LTD		
Street Address:	1-2/F, 4-5/F, NO.1-5, 1-6 PLANTS, TONGFUYU INDUSTRIAL ESTATE,		
Internal Address:	AIQUN ROAD, SHIYAN TOWN, BAO'AN DISTRICT,		
City:	SHENZHEN, GUANGDONG		
State/Country:	CHINA		
Postal Code:	518067		

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number		
Application Number:	14932450		

#### **CORRESPONDENCE DATA**

**Fax Number:** (866)335-6496

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Correspondent Name: JACKSON INTELLECTUAL PROPERTY GROUP PLLC

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Address Line 4: SHIPMAN, VIRGINIA 22971

ATTORNEY DOCKET NUMBER:	7002.610	
NAME OF SUBMITTER:	DEMIAN K. JACKSON	
SIGNATURE:	/Demian K. Jackson/	
DATE SIGNED:	11/06/2015	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

**Total Attachments: 1** 

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PATENT REEL: 036975 FRAME: 0721

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# DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE

Title of Invention	CONNECTOR PLUG			
As the below named inventor, I hereby declare that:				
This declaration 🗵	The attached application, or			
is directed to:	United States application or PCT international a	application	number	
	filed on			
-	pplication was made or authorized to be made by r			
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.				
WHEREAS, SHENZHEN LITCKCONN TECHNOLOGY CO., Ltd. (hereinafter referred to as "ASSIGNEE") having places of business at: 1,2,4,5/F, Plants No.1-5, 1-6, Tongfuyu Industrial Estate, Aigun Road, Shiyan Town, Baoan District, Shenzhen, Guangdong 518067, China , is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;				
NOW, THEREFORE, in consideration of good and valuable consideration, the receipt whereof is hereby acknowledged, I, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries (including the right to claim priority under the terms of the International Convention and other relevant International Treaties and Arrangements from the aforesaid application) and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.				
I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.				
Further, I agree that I will communicate to said ASSIGNEE or its (his) representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.				
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the Duty to Disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.				
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.				
LEGAL NAME OF INVENTOR				
Inventor: Hu	ilup DENG	Date:	March 20, 2015	
Signature:		. V.		

JACKSON INTELLECTUAL PROPERTY GROUP PLLC

106 STARVALE LANE SHIPMAN, VA 22971

> PATENT REEL: 036975 FRAME: 0722

**RECORDED: 11/06/2015**